# 1A, 200V - 1000V Fast Recovery Surface Mount Rectifier

## **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

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- DC to DC converter
- Switching mode converters and inverters
- · General purpose

## **MECHANICAL DATA**

· Case: Thin SMA

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

• Weight: 0.029g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
l <sub>F</sub>	1	Α			
$V_{RRM}$	200 - 1000	V			
I <sub>FSM</sub>	30	Α			
T <sub>J MAX</sub>	175	°C			
Package	Thin SMA				
Configuration	Single die				







Thin SMA



PARAMETER		SYMBOL	RS1DAL	RS1GAL	RS1JAL	RS1KAL	RS1MAL	UNIT
Marking code on the device			RS1DAL	RS1GAL	RS1JAL	RS1KAL	RS1MAL	
Repetitive peak reverse voltage		$V_{RRM}$	200	400	600	800	1000	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	140	280	420	560	700	V
Forward current		lF	1				Α	
Surge peak forward current single half sine wave superimposed on rated load $t = 8.3 \text{ms}$ $t = 1.0 \text{ms}$		I <sub>FSM</sub>			30			Α
		IFSM			100			Α
Junction temperature		TJ	-55 to +175				°C	
Storage temperature		T <sub>STG</sub>	-55 to +175			°C		



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	R <sub>OJL</sub>	19	°C/W		
Junction-to-ambient thermal resistance	Reja	81	°C/W		
Junction-to-case thermal resistance	Rejc	19	°C/W		

**Thermal Performance Note:** Units mounted on PCB (5mm x 5mm Cu pad test board)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
		I <sub>F</sub> = 0.5A, T <sub>J</sub> = 25°C	VF	0.90	-	V
	RS1DAL RS1GAL RS1JAL	I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C		0.97	1.30	V
		I <sub>F</sub> = 0.5A, T <sub>J</sub> = 125°C		0.75	-	V
<b>F</b> (1)		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C		0.83	0.94	V
Forward voltage <sup>(1)</sup>	RS1KAL RS1MAL	I <sub>F</sub> = 0.5A, T <sub>J</sub> = 25°C		0.96	-	V
		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 25°C		1.04	1.30	V
		I <sub>F</sub> = 0.5A, T <sub>J</sub> = 125°C		0.80	-	V
		I <sub>F</sub> = 1.0A, T <sub>J</sub> = 125°C		0.90	1.11	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		T <sub>J</sub> = 25°C	1_	-	1	μΑ
		T <sub>J</sub> = 125°C	$I_{R}$	-	33	μΑ
	RS1DAL RS1GAL		t <sub>rr</sub>	-	150	ns
Reverse recovery time	RS1JAL	$I_F = 0.5A$ , $I_R = 1.0A$ , $I_{rr} = 0.25A$		-	250	ns
	RS1KAL RS1MAL	3.23		-	500	ns
Junction capacitance		$1MHz, V_R = 4.0V$	СJ	7	-	pF

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE <sup>(1)</sup> PACKAGE PACKING					
RS1xAL	Thin SMA	14,000 / Tape & Reel			

## Notes:

1. "x" defines voltage from 200V(RS1DAL) to 1000V(RS1MAL)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

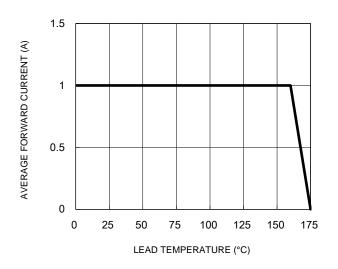


Fig.3 Typical Reverse Characteristics

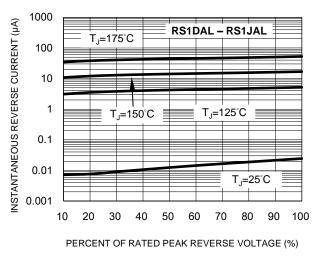


Fig.5 Typical Reverse Characteristics

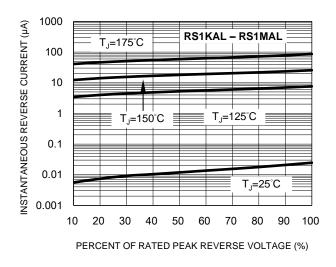


Fig.2 Typical Junction Capacitance

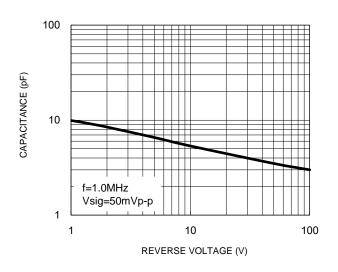


Fig.4 Typical Forward Characteristics

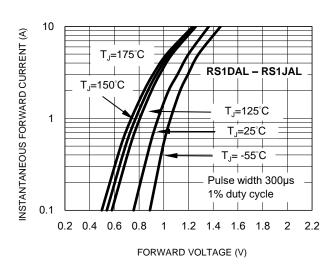
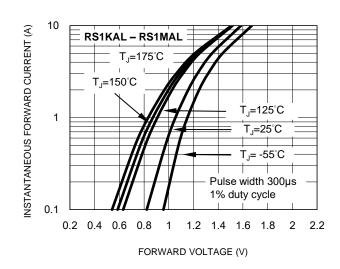


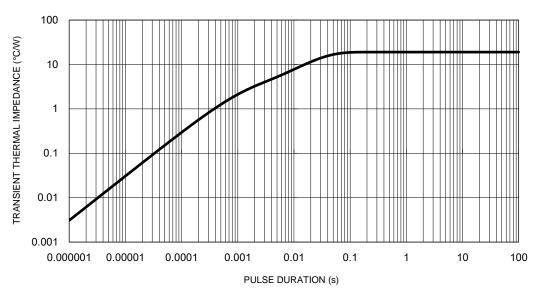
Fig.6 Typical Forward Characteristics



# **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

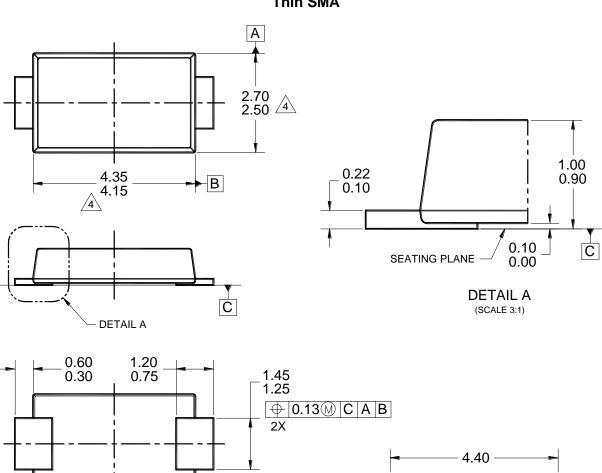
Fig.7 Typical Transient Thermal Impedance

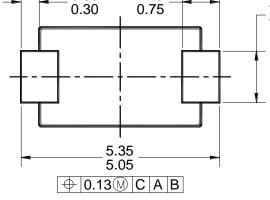


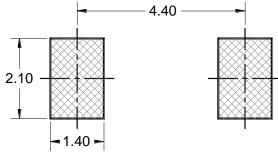


# **PACKAGE OUTLINE DIMENSIONS**

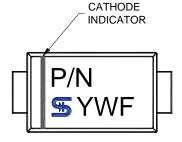
### Thin SMA







SUGGESTED PAD **LAYOUT** 



# NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-221, VARIATION AC, ISSUE B.
- MODED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
  - SUGGESTED PAD LAYOUT IS FOR REFERENCE PURPOSE ONLY.
- 6. DWG NO. REF: HQ2SD07-TSMA-074 REV A.

#### MARKING DIAGRAM

P/N = MARKING CODE YW = DATE CODE = FACTORY CODE



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